TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-IC

TLP715

Isolated Bus Drivers
High Speed Line Receivers
Microprocessor System Interfaces

The Toshiba TLP715 consists of a GaAlAs light-emitting diode and an integrated high-gain, high-speed photodetector. This unit is a 6-pin SDIP. The TLP715 is 50% smaller than the 8-PIN DIP and meets the reinforced insulation class requirements of international safety standards. Therefore the mounting area can be reduced in equipment requiring safety standard certification.

The detector has a totem pole output stage to provide both source and sink driving. The detector IC has an internal shield that provides a guaranteed common-mode transient immunity of 10 kV $/ \mu s$.

The TLP715 is buffer logic type. For inverter logic type, the TLP718 is in line-up.

- Buffer logic output (totem pole output)
- Guaranteed performance over temperature: −40 to 100°C
- Power supply voltage: 4.5 to 20 V
- Input current: I_{FLH} = 3 mA (max)
- Switching time (t_{pLH} / t_{pHL}): 250 ns (max)
- Common-mode transient immunity: ±10 kV / μs (min)
- Isolation voltage: 5000 Vrms (min)
- UL recognized

UL1577, File No.E67349

- c-UL recognized
 - CSA Component Acceptance Service No. 5A, File No.E67349
- Option (D4)

TÜV recognized / VDE under application: DIN EN60747-5-5

Maximum Operating Insulation Voltage: 890 V_{PK} Highest Permissible Over Voltage : 8000 V_{PK}

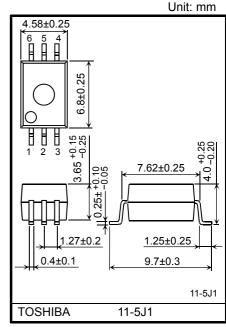
(Note): When a EN60747-5-5 approved type is needed, Please designate "Option(D4)"

Construction Mechanical Rating

	7.62 mm pitch TLPXXX type	10.16 mm pitch TLPXXXF type
Creepage Distance Clearance Insulation Thickness	7.0 mm (min) 7.0 mm (min) 0.4 mm (min)	8.0 mm (min) 8.0 mm (min) 0.4 mm (min)

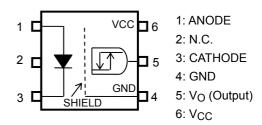
Truth Table

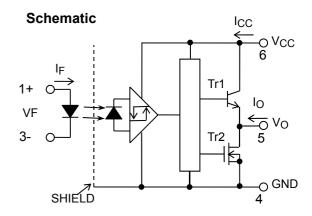
Input	LED	Tr1	Tr2	Output
Н	ON	ON	OFF	Н
L	OFF	OFF	ON	L



Weight: 0.26 g (typ.)

Pin Configuration (Top View)





 $0.1~\mu F$ bypass capacitor must be connected between pins 6 and 4. (Note 5)

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current (Ta ≤ 83°C)	l _F	20	mA
	Forward Current Derating (Ta ≥ 83°C)	ΔI _F /ΔTa	-0.48	mA/°C
LED	Peak Transient Forward Current (Note 1)	I _{FPT}	1	Α
	Reverse Voltage	V _R	5	V
	Junction Temperature	Tj	125	°C
	Output Current 1 (Ta ≤ 25°C)	I _{O1}	25 / -15	mA
SR	Output Current 2 (Ta ≤ 100°C) Output Voltage Supply Voltage		13 / -13	mA
TECT			-0.5 to 20	V
.H			-0.5 to 20	V
	Junction Temperature	Tj	125	°C
Operating Temperature Range		Topr	-40 to 100	°C
Storage Temperature Range		Tstg	-55 to 125	°C
Lead	Lead Solder Temperature (10 s)		260	°C
Isola	tion Voltage (AC,1 minute, R.H. ≤ 60%, Ta = 25°C) (Note 2)	BVS	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width PW ≤ 1µs, 300pps.

Note 2: Device Considered a two terminal device: pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Input Current, ON	IF (ON)	4.5	ı	10	mA
Input Voltage, OFF	V _F (OFF)	0	-	0.8	٧
Supply Voltage*	V _{CC}	4.5	-	20	٧
Operating Temperature	T _{opr}	-40	-	100	°C

^{*} This item denotes operating ranges, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Unless otherwise specified, Ta =-40 to 100°C, V_{CC} = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	C	ONDI	TION	MIN	TYP. *	MAX	UNIT
Input forward voltage	V _F	-	I _F = 5 mA ,	Ta = 2	25°C	1.4	1.6	1.7	V
Temperature coefficient of forward voltage	ΔV _F /ΔTa	-	I _F = 5 mA			-	-2.0	ı	mV/°C
Input reverse current	I _R	ı	V _R = 5 V , T	ā = 2	5°C	-	ı	10	μΑ
Input capacitance	C _T	ı	V = 0 V, f =	1 MH	z, Ta = 25°C	-	45	-	pF
Logic LOW output voltage	V _{OL}	1	I _{OL} = 3.5 m.	A, V _F	= 0.8 V	-	0.2	0.6	V
	V _{OH}	_	I _{OH} = −2.6 ı	mA,	V _{CC} = 4.5 V	2.7	3.5	-	
Logic HIGH output voltage	(Note3)	2	$I_F=5 \text{ mA}$ $V_{CC} = 20 \text{ V}$		17.4	19	-	V	
Logic LOW supply current	I _{CCL}	3	V _F = 0V			-	-	3.0	mA
Logic HIGH supply current	ICCH	4	I _F = 5 mA			-	-	3.0	mA
Logic LOW short circuit		_	.,	Vcc	= V _O = 5.5 V	15	80	ı	
output current (Note4)	losL	5	V _F = 0V	V _C C	= V _O = 20 V	20	90	1	mA
Logic HIGH short circuit	Lance	6	I _F = 5mA,	Vcc	= 5.5 V	- 5	-15	-	∞ Λ
output current (Note4)	losh	0	V _O = GND	$V_O = GND$ $V_{CC} = 20 V$		-10	-20	-	mA
Input current logic HIGH output	I _{FLH}	-	I_{O} = -2.6 mA, V_{O} > 2.4 V		-	0.4	3	mA	
Input voltage logic LOW output	V_{FHL}	ı	I _O = 3.5 mA, V _O < 0.6V		0.8	ı	ı	V	
Input current hysteresis	I _{HYS}	-	V _{CC} = 5 V			-	0.05	-	mA

^{*} All typical values are at Ta=25°C, V_{CC}=5 V unless otherwise specified

Note 3: $V_{OH} = V_{CC} - V_O[V]$

Note 4: Duration of output short circuit time should not exceed 10 ms.

Note 5: A ceramic capacitor $(0.1 \, \mu F)$ should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Isolation Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance input to output	Cs	V = 0 V, f = 1 MHz (Note 2)	-	1.0	-	pF
Isolation resistance	R _S	R.H. ≤ 60%, V _S = 500 V (Note 2)	1×10 ¹²	10 ¹⁴	-	Ω
		AC, 1 minute	5000	-	-	V
Isolation voltage	BV_S	AC, 1 second, in oil	-	10000	-	V _{rms}
		DC, 1 minute, in oil	ı	10000	ı	Vdc

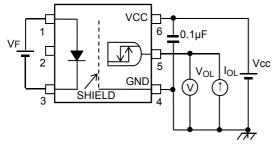
Switching Characteristics

(Unless otherwise specified, Ta = -40 to 100°C, Vcc = 4.5 to 20 V)

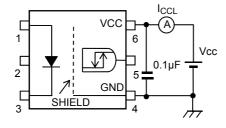
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CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION	MIN	TYP. *	MAX	UNIT
Propagation delay time to logic HIGH output	t _{pLH}		$I_F = 0 \rightarrow 3 \text{ mA}$	30	120	250	ns
Propagation delay time to logic LOW output	t _{pHL}		$I_F = 3 \rightarrow 0 \text{ mA}$	30	120	250	ns
Switching time dispersion between ON and OFF	t _{pLH} - t _{pHL}	7,8	-	-	ı	220	ns
Rise Time (10 – 90 %)	t _r		$I_F = 0 \rightarrow 3 \text{ mA}, V_{CC} = 5 \text{ V}$	-	30	-	ns
Fall Time (90 – 10 %)	t _f		$I_F = 3 \rightarrow 0 \text{ mA}, V_{CC} = 5 \text{ V}$	-	30	ı	ns
Common-mode transient Immunity at HIGH level output	CM _H		V_{CM} = 1000 V_{p-p} , I_F = 5 mA, V_{CC} = 20 V, Ta = 25°C	10000	-	ı	V/µs
Common-mode transient Immunity at LOW level output	CML	9	V_{CM} = 1000 V_{p-p} , I_F = 0 mA, V_{CC} = 20 V, Ta = 25°C	-10000	ı	ı	V/µs

^{*}All typical values are at Ta = 25°C.

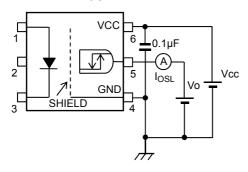




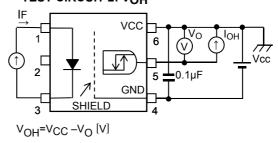
TEST CIRCUIT 3: ICCL



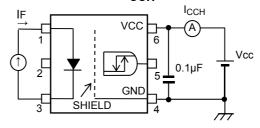
TEST CIRCUIT 5: IOSL



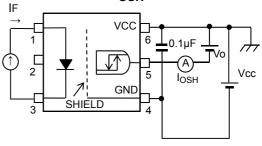
TEST CIRCUIT 2: VOH



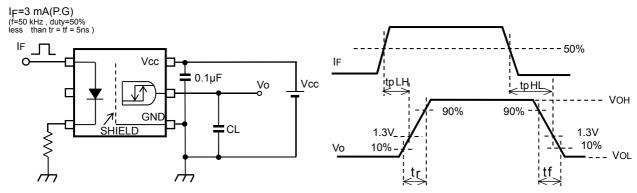
TEST CIRCUIT 4: ICCH



TEST CIRCUIT 6: IOSH

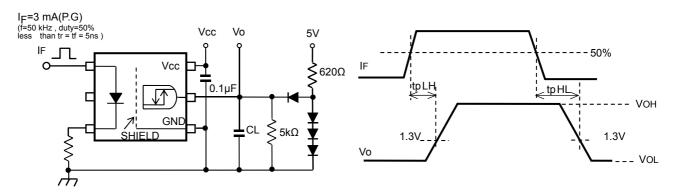


TEST CIRCUIT 7: Switching Time Test Circuit



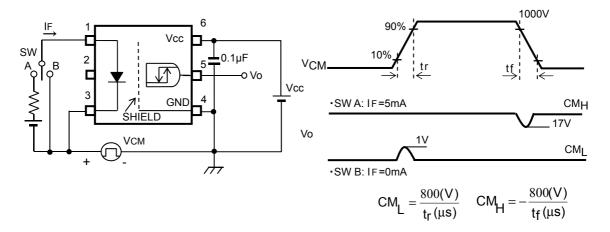
CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 8: Switching Time Test Circuit



CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 9: Common-Mode Transient Immunity Test Circuit



 ${\rm CM_H}$ (${\rm CM_L}$) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the high (low) state.

EN60747-5-5 Option:(D4)

Types : TLP715, TLP715F

Type designations for "option: (D4)", which are tested under EN60747 requirements.

Ex.: TLP715 (D4-TP,F) D4 : EN60747 option

TP : Standard tape & reel type F : [[G]]/RoHS COMPATIBLE

Note: Use TOSHIBA standard type number for safety standard application.

Ex.: TLP715 (D4-TP,F) \rightarrow TLP715

EN60747 Isolation Characteristics

Description	Symbol	Rating	Unit	
Application classification				
for rated mains voltage≤300V _{rms} for rated mains voltage≤600V _{rms}			I-IV I-III	_
Climatic classification			40/ 100 / 21	_
Pollution degree			2	_
Maximum aparating insulation voltage	TLPxxx type	V	890	Vpk
Maximum operating insulation voltage	TLPxxxFtype	V _{IORM}	1140	
Input to output test voltage, method A	TLPxxx type		1335	Vpk
Vpr=1.5×V _{IORM} , type and sample test tp=10s, partial discharge<5pC	TLPxxxFtype	Vpr	1710	
Input to output test voltage, method B	TLPxxx type	Vpr	1670	Vpk
Vpr=1.875×V _{IORM} , 100% production test t _p =1s, partial discharge<5pC	TLPxxxFtype		2140	
Highest permissible overvoltage (transient overvoltage, t _{pr} = 60s)		V _{TR}	8000	Vpk
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating current (input current I_F , P_{si} = 0) power (output or total power dissipation) temperature	Isi Psi Tsi	300 700 150	mA mW °C	
Insulation resistance, input-output V_{IO} =500V, V_{IO} =500V, V_{IO} =500V, V_{IO} =500V,	Ta=100°C	Rsi	≥10 ¹² ≥10 ¹¹ ≥10 ⁹	Ω

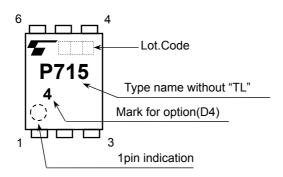
Insulation Related Specifications

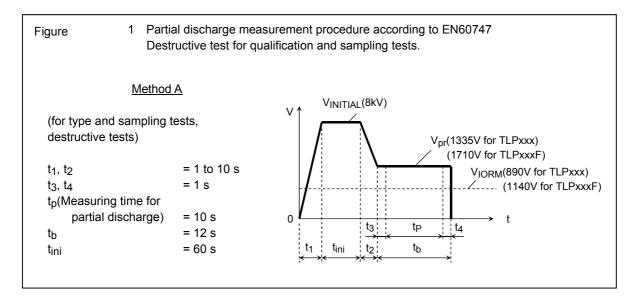
		7.62mm pitch TLPxxx type	10.16mm pitch TLPxxxF type	
Minimum creepage distance	Cr	7.0mm	8.0mm	
Minimum clearance	CI	7.0mm	8.0mm	
Minimum insulation thickness	ti	0.4mm		
Comperative tracking index	CTI	175		

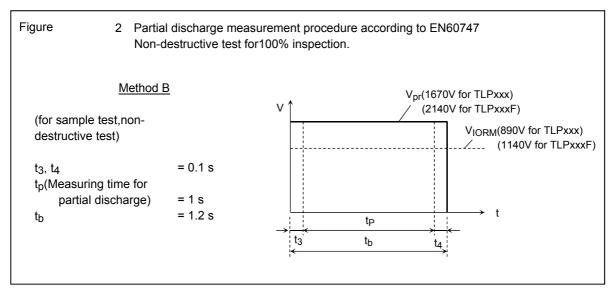
- 1. If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. (e.g.at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.
- 2. This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.

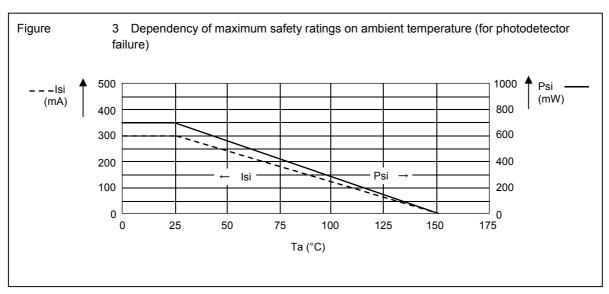
Marking on product for EN60747 Option:(D4):

Marking Example:









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